ELSEVIER

Contents lists available at ScienceDirect

### Materials Research Bulletin

journal homepage: www.elsevier.com/locate/matresbu



# Effect of chemical etching on the surface morphology of laser-patterned lines with Er<sup>3+</sup>-doped CaF<sub>2</sub> nanocrystals in oxyfluoride glass

M. Kanno, T. Honma, T. Komatsu\*

Department of Materials Science and Technology, Nagaoka University of Technology, 1603-1 Kamitomioka-cho, Nagaoka 940-2188, Japan

#### ARTICLE INFO

Article history: Received 29 May 2009 Received in revised form 27 June 2009 Accepted 30 June 2009 Available online 9 July 2009

Keywords:

- A. Glasses
- A. Nanostructures
- A. Optical materials
- D. Luminescence
- D. Surface properties

#### ABSTRACT

The chemical etching behavior for the lines consisting of  $Er^{3+}$ -doped  $CaF_2$  nanocrystals patterned on the surface of an oxyfluoride glass by using a laser-induced crystallization technique (laser: Yb-doped YVO $_4$ ; wavelength: 1080 nm; power: 1.7 W; a scanning speed: 2  $\mu$ m/s) in a nitric acid solution (1N HNO $_3$ ) is examined, and the morphology change in the lines due to the etching is characterized from confocal laser microscope observations and photoluminescence (PL) spectrum measurements of  $Er^{3+}$  ions. The higher and wider bumps compared with the bump of the original line (no etching) are observed in etched lines, and in particular, the surrounding of lines is etching away preferentially, forming the groove in both sides of line. PL spectra of  $Er^{3+}$  ions with strong intensities are observed from etched lines, suggesting that  $Er^{3+}$ -doped  $CaF_2$  nanocrystals are largely present just at the surface of etched lines. It is found that the chemical etching rate  $(1.2 \times 10^{-2} \, \mu \text{m/min})$  of the crystallized bulk sample is smaller than that  $(5.4 \times 10^{-2} \, \mu \text{m/min})$  of the precursor bulk glass, suggesting that  $CaF_2$  nanocrystals formed have a high resistance against the chemical attack.

© 2009 Elsevier Ltd. All rights reserved.

#### 1. Introduction

Transparent oxyfluoride-based crystallized glasses (glass-ceramics) consisting of fluoride nanocrystals have received much attention [1–6]. In such materials, for instance, rare-earth (RE<sup>3+</sup>) ions are incorporated into fluoride nanocrystals embedded in SiO<sub>2</sub>based oxide glass matrices with high thermal/chemical stabilities, and photoluminescence (PL) spectra with strong intensities are observed from RE3+-doped fluoride nanocrystals with low phonon energies. Usually, oxyfluoride-based crystallized glasses are fabricated through well-controlled heat treatments in an electric furnace. Recently, a laser-induced crystallization technique has been applied to oxyfluoride glasses, and lines consisting of LaF<sub>3</sub> or CaF<sub>2</sub> nanocrystals have been patterned [7–9]. Spatially selected crystallization of fluoride crystals in oxyfluoride glasses would give a high potential for optical device applications such as waveguidetype amplifications, and it is of interest to characterize morphologies and properties of fluoride crystal lines patterned by lasers.

Very recently, Hirokawa et al. [10] and Honma et al. [11] applied a combination technique of laser irradiation and chemical etching (e.g., 1N HNO<sub>3</sub> solution) to nonlinear optical  $Ba_2TiGe_2O_8$  crystal dots and lines on the glass surface and proposed that its technique is effective in constructing the micro-architecture of crystal dot array and patterned line. The key-point in their studies is that

chemical etching rates of the precursor glass and crystallized part in an acid solution are different largely [10,11]. It is of interest and importance to clarify the chemical etching behavior in oxyfluoride glasses and crystallized glasses with fluoride nanocrystals for their device applications. There have been, however, no reports on chemical etching of oxyfluoride glasses and their ceramics so far.

The purpose of this study is to examine the chemical etching behavior for laser-induced crystal lines consisting of Er³+-doped CaF₂ nanocrystals in oxyfluoride glasses and to clarify the change in the surface morphology and PL spectra after chemical etching. In this study, it has been clarified that the chemical etching rate for the patterned lines in a nitric acid solution (1N HNO₃) is smaller than that for the precursor oxyfluoride glass (non-irradiated part). A combination technique of laser-induced crystallization and simple chemical etching is proposed to be effective in designing the micro-architecture of lines with CaF₂ nanocrystals in oxyfluoride glasses. Lines consisting of Er³+-doped CaF₂ nanocrystals in oxyfluoride glasses have been already successfully patterned using a laser-induced crystallization technique by our research group [7,9].

#### 2. Experimental

In this study, an oxyfluoride glass with the composition of  $41.5 \text{SiO}_2 - 21.3 \text{Al}_2 \text{O}_3 - 4.8 \text{CaO} - 12.6 \text{NaF} - 16.4 \text{CaF}_2 - 2.9 \text{NiO} - 0.5 \text{ErF}_3$  (mol.%) (designated here as Glass A) was examined [9]. The glasses were prepared using a conventional melt quenching method. Commercial powders of raw materials of SiO<sub>2</sub>, Al<sub>2</sub>O<sub>3</sub>, CaCO<sub>3</sub>, NaF,

<sup>\*</sup> Corresponding author. Tel.: +81 258 47 9313; fax: +81 258 47 9300. E-mail address: komatsu@mst.nagaokaut.ac.jp (T. Komatsu).

CaF<sub>2</sub>, NiO, and ErF<sub>3</sub> were mixed and melted in a platinum crucible with a lid at 1400 °C for 1.5 h in air in an electric furnace. The melts were poured onto an iron plate and pressed to a thickness of ~2 mm with another iron plate. The glass transition,  $T_{\rm g}$ , crystallization onset,  $T_{\rm x}$ , and crystallization peak,  $T_{\rm p}$ , temperatures for the glasses (bulk samples) were determined using differential thermal analyses (DTA) at a heating rate of 20 K/min. The formation of CaF<sub>2</sub> crystals in the crystallized samples was examined from X-ray diffraction (XRD) analyses (Cu K $\alpha$  radiation) at room temperature. The incorporation of Er<sup>3+</sup> ions into CaF<sub>2</sub> crystals was confirmed from PL spectra of Er<sup>3+</sup> ions by using a micro-PL spectrum apparatus (Tokyo Instruments Co., Nanofinder; Ar<sup>+</sup> laser with a wavelength of  $\lambda$  = 488 nm).

The glasses were mechanically polished to a mirror finish with  $CeO_2$  powders. Continuous-wave (cw) Yb:YVO $_4$  fiber lasers with  $\lambda$  = 1080 nm were irradiated onto the surface of the glasses using an objective lens (magnification:  $50\times$ ; numerical aperture: NA = 0.8). The sample was put on the stage and mechanically moved during laser irradiations to construct crystal lines. After laser irradiation, wet chemical etchings with a nitric acid (HNO $_3$ ) solution (concentration: one normality, 1N) and different etching times at room temperature were carried out. The surface morphology of etched crystal lines was observed with a confocal scanning laser (CSL) microscope (Olympus-OLS 3000). The PL spectra of  $Er^{3+}$  ions in the crystal lines were measured by using a micro-PL spectrum apparatus.

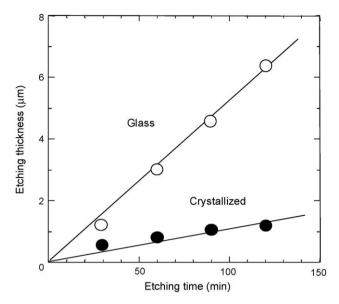
#### 3. Results and discussion

# 3.1. Chemical etching rates of bulk precursor glass and crystallized samples

The DTA pattern showed that the glass prepared in this study gives the values of  $T_{\rm g}$  = 575 °C,  $T_{\rm x}$  = 620 °C, and  $T_{\rm p}$  = 635 °C [9]. It was confirmed from the XRD patterns and PL spectra that Er<sup>3+</sup>-doped CaF<sub>2</sub> nanocrystals are formed in the samples obtained by heat treatments at  $T_{\rm x}$  and  $T_{\rm p}$  for 2 h, as already reported in previous paper [9]. That is, the average particle size, d, of CaF<sub>2</sub> crystals was estimated to be d = 17 nm for the sample heat-treated at  $T_{\rm x}$  = 620 °C and d = 20 nm for the sample heat-treated at  $T_{\rm p}$  = 635 °C from the peak width of the (2 2 0) plane in the XRD patterns by using Scherrer's equation [9].

Prior to the study of the chemical etching behavior for laserinduced crystal lines consisting of Er3+-doped CaF2 nanocrystals, the chemical etching rate of the bulk precursor oxyfluoride glass and the crystallized ( $T_p$  = 635 °C, 1 h) glass was examined. Some parts of the surfaces of glass and crystallized samples were masked by using an epoxy resin and were immersed into a solution of 1N HNO<sub>3</sub> for 30, 60, 90, and 120 min. After removing the epoxy resin, the etching depth was measured from CSL microscope observations. The results are shown in Fig. 1. It is found that the etching thickness increases almost linearly with increasing etching time. Furthermore, it is seen that the chemical etching rate of the crystallized sample, i.e.,  $1.2\times 10^{-2}~\mu\text{m/min}$ , is smaller than that  $(5.4 \times 10^{-2} \, \mu m/min)$  of the precursor glass. This new information would be very important for practical applications of aluminosilicate-based oxyfluoride glass-ceramics with RE<sup>3+</sup>-doped nanocrystals. To the best of our knowledge, there have been no reports on mechanical properties and chemical durability for oxyfluoride glass-ceramics, although numerous studies on optical properties of RE<sup>3+</sup> ions in oxyfluoride glass-ceramics have been reported.

Kiczenski and Stebbins [12] examined the fluorine sites in calcium aluminosilicate oxyfluoride glasses by using a <sup>19</sup>F magicangle spinning nuclear magnetic resonance (MAS NMR) technique and proposed that most of the F bonding is to Al, i.e., the formation of Al–F–Ca bonds, with roughly 0–30% Si–F–Ca bonds. Therefore,



**Fig. 1.** Chemical etching thickness of the crystallized (635  $^{\circ}$ C, 2 h) bulk sample and the precursor bulk glass in a solution of 1N HNO<sub>3</sub> as a function of etching time.

Ca<sup>2+</sup> ions with the high field strength can more effectively compete with Al3+ for bonding with F- in aluminosilicate oxyfluoride glasses [12]. It is known that the viscosity of Al-free silicate melts decreases with the partial substitution of 2F<sup>-</sup> for O<sup>2-</sup> [13], where the mobile fluoride anion may serve to catalyze network bond breaking [12]. On the other hand, as demonstrated in the dental science and technology, calcium fluoride (CaF<sub>2</sub>) at the surface of teeth can act as protecting layers, reducing acid dissolution of teeth [14]. It is, therefore, considered that the formation of CaF<sub>2</sub> crystals in oxyfluoride glasses would decrease the amount of F<sup>-</sup> ions acting as anions for the breaking of Si-O-Si bonds in the glassy phase and would increase the chemical resistance against the attack of acids such as HNO<sub>3</sub>. From these reasons, it is expected that the chemical etching rate of the crystallized sample with CaF<sub>2</sub> nanocrystals is much smaller than that of the precursor oxyfluoride glass, as obtained in the present study (Fig. 1).

### 3.2. Chemical etching of crystal lines with $Er^{3+}$ -doped nanocrystals

As reported in previous papers [7–9], lines consisting of fluoride crystals such as LaF3 or CaF2 are patterned in aluminosilicate oxyfluoride glasses by laser irradiations. The CSL micrograph for the sample obtained by irradiations of Yb:YVO4 fiber lasers ( $\lambda$  = 1080 nm) with a power of P = 1.7 W and a scanning speed of S = 2  $\mu$ m/s in Glass A is shown in Fig. 2(a). The bump is observed in the laser-irradiated parts, and the values of height (h) and width (w) are  $h \sim 1 \, \mu$ m and  $w \sim 3 \, \mu$ m. The formation of bump at the surface is a typical feature in the laser-induced crystallization in oxide and oxyfluoride glasses, indicating that at least the temperature in the laser-irradiated region is going up over the glass transition temperature [15,16].

The CSL micrographs for the samples obtained by chemical etchings in a nitric acid solution  $(1N\,\text{HNO}_3)$  for the etching times of t=30 and 60 min at room temperature are shown in Fig. 2(b) and (c). The higher and wider bumps compared with the bump of the original line (no etching) are observed. Furthermore, in particular, the surrounding of the lines is etching away preferentially, forming the groove in both sides of the lines. The height and width of the bumps evaluated from CSL measurements for the etched lines are summarized in Fig. 3. The results shown in Figs. 2 and 3 clearly indicate that the chemical etching rate in the lines changes largely depending on the position of line. Very recently, Kanno et al. [9]

## Download English Version:

# https://daneshyari.com/en/article/1491342

Download Persian Version:

https://daneshyari.com/article/1491342

<u>Daneshyari.com</u>